

Magnetics modules for LAN applications

10/100 Base-T magnetics module

Series/Type: B78476A8247A003

Date: March 2015

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10/100 Base-T magnetics module

B78476A8247A003

Single port, extended temperature range

SMD

Features

- Ferrite toroid, case and potting (UL 94 V-0)
- Compliant with IPC/JEDEC J-STD-020D
- Compliant with IEEE 802.3
- RoHS-compatible

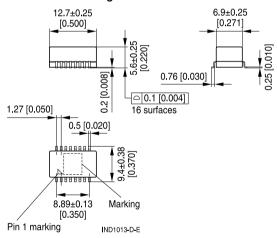
Marking

■ EPCOS, middle block of ordering code, date code

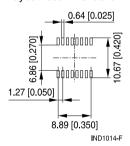
Delivery mode and packing unit

- 24-mm blister tape, 330-mm Ø reel (cardboard packaging)
- Packing unit: 500 pcs./reel

Dimensional drawing



Layout recommendation



Dimensions in mm [inch]

Values without tolerances are nominal values for reference.



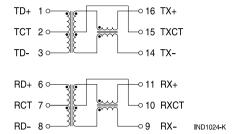
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Pinning



Characteristics and ordering code

(electrical specifications at +25 °C)

Ordering code	B78476A8247A003	
Turns ratio (primary : secondary)	1CT : 1CT ±3%	
Inductance L	350 μH min.	100 kHz, 100 mV, 8 mA DC bias
Voltage test V _{test}	1500 V AC	50 Hz, 1 min
Insertion loss	-1.0 dB max.	0.1 MHz 100 MHz
Return loss	−18 dB min.	1 MHz 30 MHz
	−16 dB min.	40 MHz
	-14 dB min.	50 MHz
	-12 dB min.	60 MHz 80 MHz
Crosstalk	-43 dB min.	30 MHz
	-37 dB min.	60 MHz
	-33 dB min.	100 MHz
Differential to common-mode	-43 dB min.	30 MHz
rejection (DCMR)	-37 dB min.	60 MHz
	-33 dB min.	100 MHz
Operating temperature range	−40 °C +85 °C	
Weight	Approx. 0.8 g	



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Cautions and warnings

- For soldering conditions of SMD components please refer to JEDEC J-STD-020D.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
 - Washing processesmay damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop n the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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Important notes

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